

N-Channel 60 V (D-S) Super Junction MOSFET

PRODUCT SUMMARY

V _{DS} (V)	R _{DS(on)} (mΩ)(Typ.)	I _D (A) ^a	Q _g (Typ.)
60	6.5 at V _{GS} = 10 V	52	22 nC
	10 at V _{GS} = 4.5 V		

FEATURES

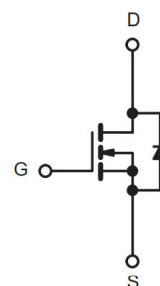
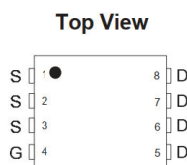
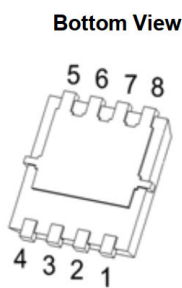
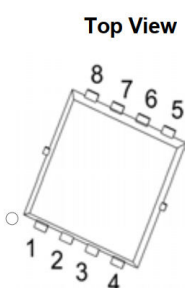
- DT-SJ Power MOSFET
- Very low on-resistance
- Excellent gate charge x R_{DS(on)} product(FOM)

APPLICATIONS

- Power Management
- Motor Drivers
- DC-DC Converters



PDFN3.3*3.3-8L Pin Configuration



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C, unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	60	V
Gate-Source Voltage	V _{GS}	± 20	
Continuous Drain Current (T _J = 150 °C)	I _D	52	A
		33	
Pulsed Drain Current	I _{DM}	208	
Single Pulse Avalanche Energy	E _{AS}	35	mJ
Maximum Power Dissipation	P _D	45 ^c	W
		15	
Operating Junction and Storage Temperature Range	T _J , T _{stg}	-55 to 150	°C
Soldering Recommendations (Peak Temperature)		260	

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient ^b	R _{thJA}	-	55	°C/W
Maximum Junction-to-Case (Drain)	R _{thJC}	-	2.8	

Notes:

a. Based on T_C = 25 °C.

b. Surface mounted on 1" x 1" FR4 board.

c. See SOA curve for voltage derating

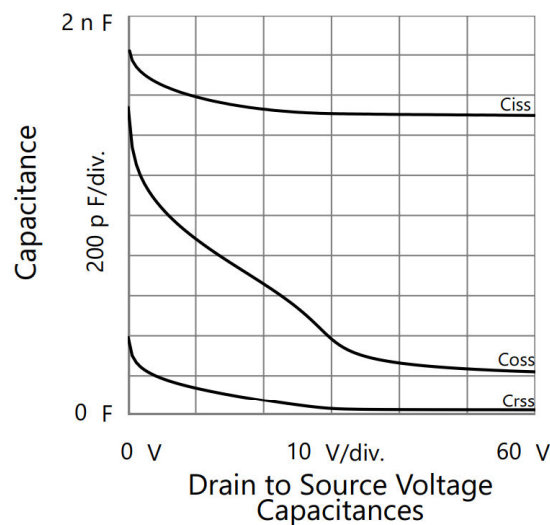
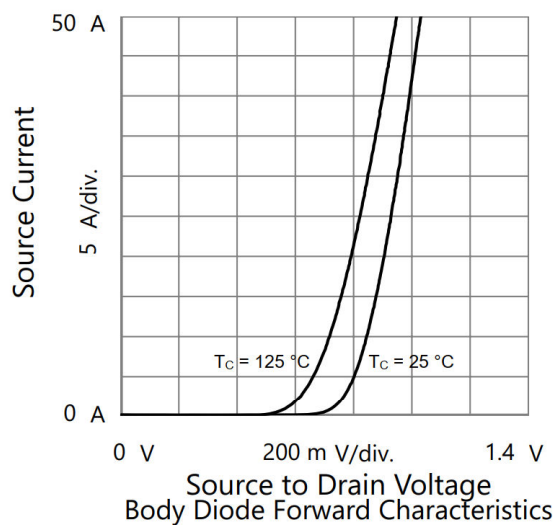
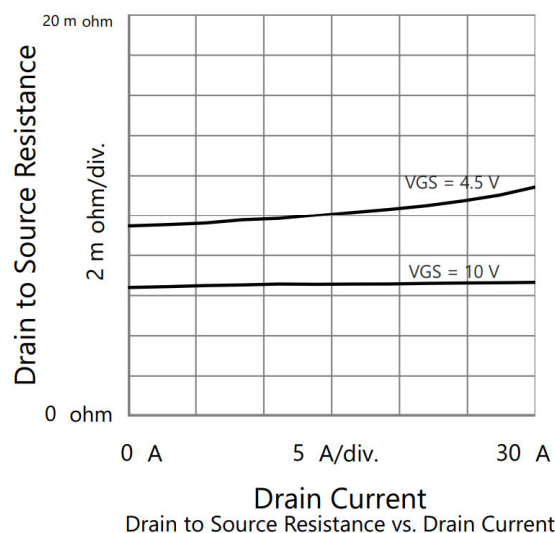
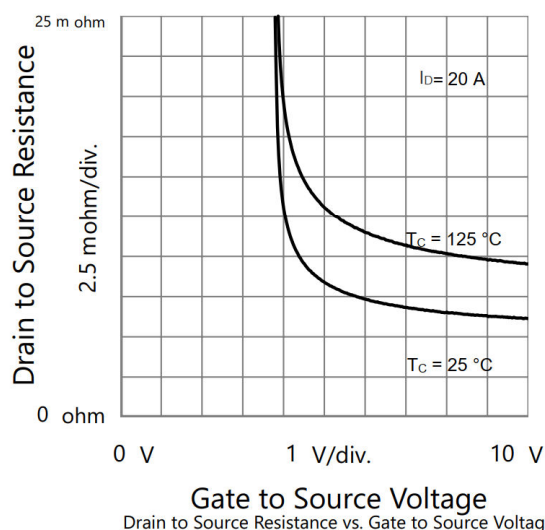
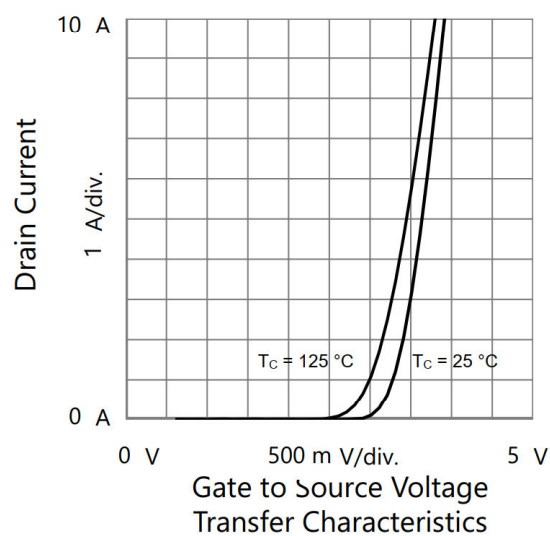
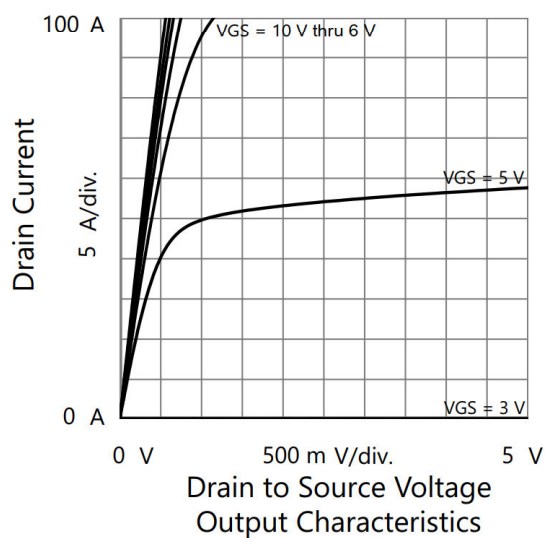
SPECIFICATIONS (T _J = 25 °C, unless otherwise noted)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static						
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = 250 μA	60	-	-	V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250 μA	2	-	4	
Gate-Body Leakage	I _{GSS}	V _{DS} = 0 V, V _{GS} = ± 20 V	-	-	± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 60 V, V _{GS} = 0 V	-	-	1	μA
		V _{DS} = 48 V, V _{GS} = 0 V, T _J = 55°C	-	-	10	
On-State Drain Current ^a	I _{D(on)}	V _{DS} = 5 V, V _{GS} = 10 V	52	-	-	A
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 10 V, I _D = 20 A	-	6.5	8	mΩ
		V _{GS} = 4.5 V, I _D = 20 A	-	10	12.5	
Forward Transconductance ^a	g _{fs}	V _{DS} = 5 V, I _D = 20 A	-	45	-	S
Dynamic ^b						
Input Capacitance	C _{iss}	V _{GS} = 0 V, V _{DS} = 30 V, f = 1MHz	-	1530	-	pF
Output Capacitance	C _{oss}		-	396	-	
Reverse Transfer Capacitance	C _{rss}		-	25	-	
Total Gate Charge ^c	Q _g	V _{DS} = 30 V, V _{GS} = 10 V, I _D = 20 A	-	22	-	nC
Gate-Source Charge ^c	Q _{gs}		-	7.6	-	
Gate-Drain Charge ^c	Q _{gd}		-	2.5	-	
Gate Resistance	R _g	f = 1 MHz	-	1.5	-	Ω
Turn-On Delay Time ^c	t _{d(on)}	V _{DD} = 30 V, R _L = 1.5 Ω I _D = 20 A, V _{GEN} = 10 V, R _g = 3 Ω	-	8	-	ns
Rise Time ^c	t _r		-	3	-	
Turn-Off Delay Time ^c	t _{d(off)}		-	12	-	
Fall Time ^c	t _f		-	3	-	
Drain-Source Body Diode Ratings and Characteristics ^b (T _C = 25 °C)						
Continuous Source Current	I _S	T _C = 25 °C	-	-	52	A
Pulsed Source Current	I _{SM}		-	-	208	A
Forward Voltage ^a	V _{SD}	I _F = 1 A, V _{GS} = 0 V	-	-	1	V
Reverse Recovery Time	t _{rr}	I _F = 20 A, di/dt = 100 A/μs	-	30	-	ns
Reverse Recovery Charge	Q _{rr}		-	29	-	nC

Notes

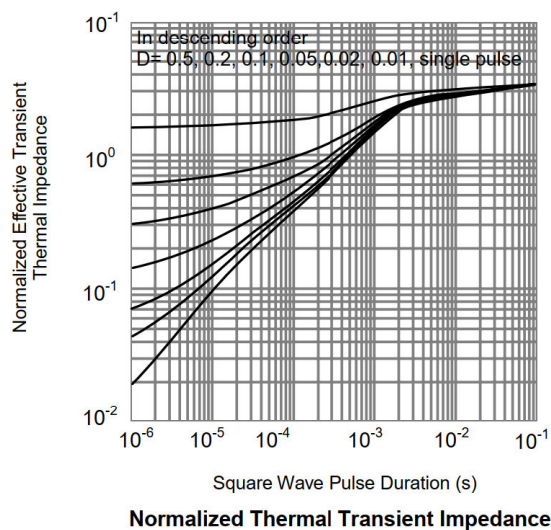
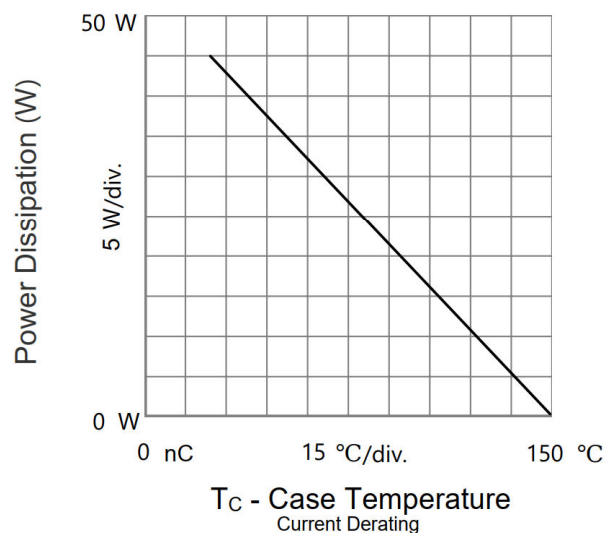
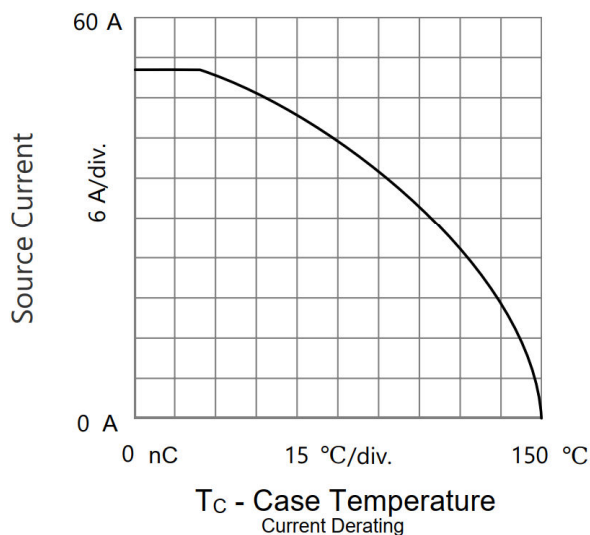
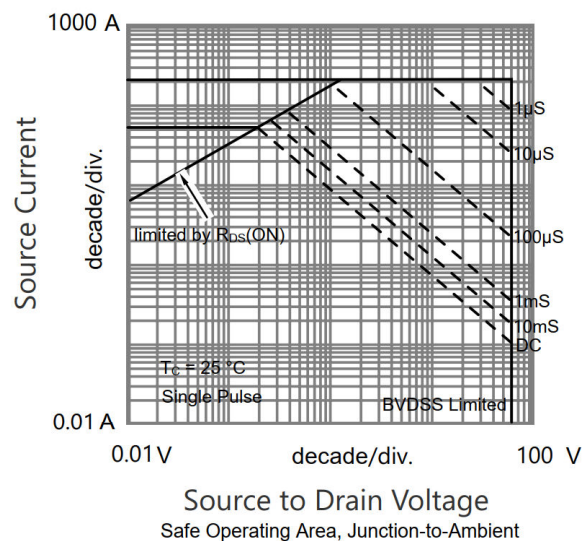
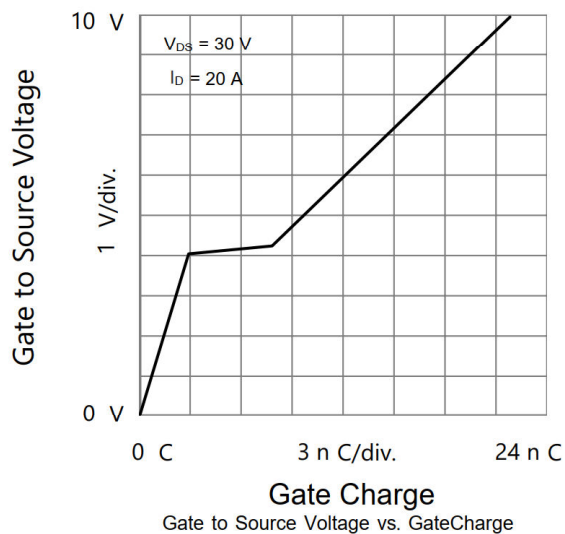
- a. Pulse test; pulse width $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$.
 b. Guaranteed by design, not subject to production testing.
 c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS ($T_A = 25\text{ }^{\circ}\text{C}$, unless otherwise noted)



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